

6-OUTPUT DB800ZL DERIVATIVE WITH INTEGRATED 850HM TERMINATIONS IDT6V61036

General Description

The IDT6V61036 is a low-power 6-output differential buffer that meets all the performance requirements of the Intel DB1200Z specification. It consumes 50% less power than standard HCSL devices and has internal terminations to allow direct connection to 85 ohm transmission lines. It is suitable for PCI-Express Gen1/2/3 or QPI/UPI applications, and uses a fixed external feedback to maintain low drift for demanding QPI/UPI applications.

Recommended Application

Buffer for Romley, Grantley and Purley Servers, SSDs and PCIe

Output Features

6 - LP-HCSL Output Pairs w/integrated terminations (Zo = 85Ω)

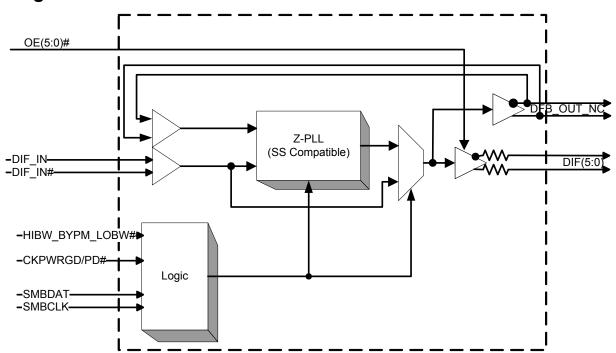
Features/Benefits

- Low-Power-HCSL outputs w/Zo = 85Ω ; save power and board space no termination resistors required. Ideal for blade servers.
- Space-saving 40-pin VFQFPN package
- Fixed feedback path for 0ps input-to-output delay
- 6 OE# pins/Hardware control of each output
- PLL or bypass mode; PLL can dejitter incoming clock
- Selectable PLL bandwidth; minimizes jitter peaking in downstream PLL's
- Spread Spectrum Compatible; tracks spreading input clock for low EMI

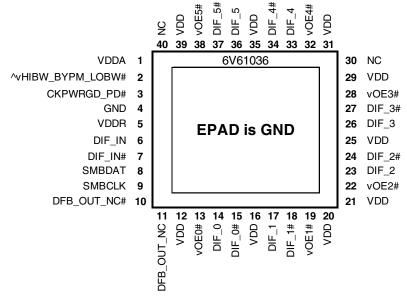
Key Specifications

- Cycle-to-cycle jitter <50ps
- Output-to-output skew <65ps
- Input-to-output delay variation <50ps
- PCIe Gen3 phase jitter <1.0ps RMS
- QPI/UPI 9.6GT/s 12UI phase jitter <0.2ps RMS

Block Diagram



Pin Configuration



40-VFQFPN

^ prefix indicates internal Pull-Up Resistor
v prefix indicates Internal Pull-Down Resistor
^v prefix indicates Internal Pull-Up/Down Resistor (biased to
VDD/2)
5mm x 5mm 0.4mm pin pitch

Power Management Table

| CKPWRGD_PD# | DIF_IN/ DIF_IN# | SMBus EN bit | DIF(5:0)/ DIF(5:0)# | PLL STATE IF NOT IN BYPASS MODE |
|-------------|--------------------|-----------------|------------------------|------------------------------------------|
| 0 | X | Χ | Low/Low | OFF |
| 4 | Dunning | 0 | Low/Low | ON |
| I | Running | 1 | Running | ON |

PLL Operating Mode

| HiBW_BypM_LoBW# | MODE |
|-----------------|-----------|
| Low | PLL Lo BW |
| Mid | Bypass |
| Hiah | PLL Hi BW |

NOTE: PLL is OFF in Bypass Mode

Power Connections

| Pin No | umber | |
|----------------|-------|--------------|
| VDD | GND | Description |
| 1 | 41 | Analog PLL |
| 5 | 4 | Analog Input |
| 12,16,20,24,27 | 44 | DIE dede |
| ,31,32,36,40 | 41 | DIF clocks |

PLL Operating Mode Readback Table

| HiBW_BypM_LoBW# | Byte0, bit 7 | Byte 0, bit 6 |
|-----------------|--------------|---------------|
| Low (Low BW) | 0 | 0 |
| Mid (Bypass) | 0 | 1 |
| High (High BW) | 1 | 1 |

Tri-level Input Thresholds

| Level | Voltage |
|-------|-----------------------------------|
| Low | <0.8V |
| Mid | 1.2 <vin<1.8v< th=""></vin<1.8v<> |
| High | Vin > 2.2V |

IDT6V61036 SMBus Address

| 1101100 | + Read/Write bit |
|---------|------------------|

Pin Descriptions

| PIN# | PIN NAME | PIN TYPE | DESCRIPTION |
|------|------------------------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1 | VDDA | PWR | 3.3V power for the PLL core. |
| 2 | ^vHIBW_BYPM_LOBW# | LATCHE | Trilevel input to select High BW, Bypass or Low BW mode. |
| | *VIIIDVV_DII WI_LODVV# | D IN | See PLL Operating Mode Table for Details. |
| 3 | CKPWRGD_PD# | Trays | 3.3V Input notifies device to sample latched inputs and start up on first high assertion, or |
| | OKI WIKOD_I D# | Hays | exit Power Down Mode on subsequent assertions. Low enters Power Down Mode. |
| 4 | GND | GND | Ground pin. |
| 5 | VDDR | PWR | 3.3V power for differential input clock (receiver). This VDD should be treated as an |
| | DIE IN | 18.1 | analog power rail and filtered appropriately. |
| 6 | DIF_IN | IN | 0.7 V Differential True input |
| 7 | DIF_IN# | IN | 0.7 V Differential Complementary Input |
| 8 | SMBDAT | I/O | Data pin of SMBUS circuitry, 5V tolerant |
| 9 | SMBCLK | IN | Clock pin of SMBUS circuitry, 5V tolerant |
| 10 | DED OUT NO# | OUT | Complementary half of differential feedback output, provides feedback signal to the PLL |
| 10 | DFB_OUT_NC# | OUT | for synchronization with input clock to eliminate phase error. This pin should NOT be |
| | | | connected on the circuit board, the feedback is internal to the package. True half of differential feedback output, provides feedback signal to the PLL for |
| 11 | DFB_OUT_NC | OUT | synchronization with the input clock to eliminate phase error. This pin should NOT be |
| '' | DFB_OUT_NC | 001 | connected on the circuit board, the feedback is internal to the package. |
| 12 | VDD | PWR | Power supply, nominal 3.3V |
| | | | Active low input for enabling DIF pair 0. This pin has an internal pull-down. |
| 13 | vOE0# | IN | 1 =disable outputs, 0 = enable outputs |
| 14 | DIF_0 | OUT | 0.7V differential true clock output |
| 15 | DIF_0# | OUT | 0.7V differential Complementary clock output |
| 16 | VDD | PWR | Power supply, nominal 3.3V |
| 17 | DIF_1 | OUT | 0.7V differential true clock output |
| 18 | DIF_1# | OUT | 0.7V differential Complementary clock output |
| 19 | vOE1# | IN | Active low input for enabling DIF pair 1. This pin has an internal pull-down. 1 = disable outputs, 0 = enable outputs |
| 20 | VDD | PWR | Power supply, nominal 3.3V |
| 21 | VDD | PWR | Power supply, nominal 3.3V |
| | | | Active low input for enabling DIF pair 2. This pin has an internal pull-down. |
| 22 | vOE2# | IN | 1 = disable outputs, 0 = enable outputs |
| 23 | DIF_2 | OUT | 0.7V differential true clock output |
| 24 | DIF_2# | OUT | 0.7V differential Complementary clock output |
| 25 | VDD | PWR | Power supply, nominal 3.3V |
| 26 | DIF_3 | OUT | 0.7V differential true clock output |
| | DIF_3# | OUT | 0.7V differential Complementary clock output |
| | | | Active low input for enabling DIF pair 3. This pin has an internal pull-down. |
| 28 | vOE3# | IN | 1 =disable outputs, 0 = enable outputs |
| 29 | VDD | PWR | Power supply, nominal 3.3V |
| 30 | NC | N/A | No Connection. |
| 31 | VDD | PWR | Power supply, nominal 3.3V |
| 32 | vOE4# | IN | Active low input for enabling DIF pair 4. This pin has an internal pull-down. 1 = disable outputs, 0 = enable outputs |
| 33 | DIF_4 | OUT | 0.7V differential true clock output |
| 34 | DIF_4# | OUT | 0.7V differential Complementary clock output |
| 35 | VDD | PWR | Power supply, nominal 3.3V |
| 36 | DIF_5 | OUT | 0.7V differential true clock output |
| 37 | DIF_5# | OUT | 0.7V differential Complementary clock output |
| | vOE5# | IN | Active low input for enabling DIF pair 5. This pin has an internal pull-down. |
| 38 | VUE3# | IIN | 1 =disable outputs, 0 = enable outputs |
| 39 | VDD | PWR | Power supply, nominal 3.3V |
| 40 | NC | N/A | No Connection. |
| 41 | EPAD | GND | Ground Pad. |

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Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the IDT6V61036. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|--------------------------|--------------------|----------------------------|---------|-----|-----------------------|-------|-------|
| | VDD, VDDA, | | | | | | |
| 3.3V Core Supply Voltage | VDDR | VDD for core logic and PLL | | | 4.6 | V | 1,2 |
| Input Low Voltage | V_{IL} | | GND-0.5 | | | V | 1 |
| Input High Voltage | V _{IH} | Except for SMBus interface | | | V _{DD} +0.5V | V | 1 |
| Input High Voltage | V _{IHSMB} | SMBus clock and data pins | | | 5.5V | ٧ | 1 |
| Storage Temperature | Ts | | -65 | | 150 | °C | 1 |
| Junction Temperature | Tj | | | | 125 | °C | 1 |
| Input ESD protection | ESD prot | Human Body Model | 2000 | | | V | 1 |

¹Guaranteed by design and characterization, not 100% tested in production.

Electrical Characteristics-DIF_IN Clock Input Parameters

 $T_A = T_{COM}$; Supply Voltage $V_{DD} = 3.3 V + -5\%$

| A COMP - SPPT - STORE OF SPECIAL PROPERTY. | | | | | | | |
|--------------------------------------------|--------------------|----------------------------------------|-----|-----|-----|-------|-------|
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
| Input Crossover Voltage - DIF_IN | V _{CROSS} | Cross Over Voltage | 150 | | 900 | mV | 1 |
| Input Swing - DIF_IN | V _{SWING} | Differential value | 300 | | | mV | 1 |
| Input Slew Rate - DIF_IN | dv/dt | Measured differentially | 0.4 | | 8 | V/ns | 1,2 |
| Input Leakage Current | I _{IN} | $V_{IN} = V_{DD}$, $V_{IN} = GND$ | -5 | | 5 | uA | |
| Input Duty Cycle | d _{tin} | Measurement from differential wavefrom | 45 | | 55 | % | 1 |
| Input Jitter - Cycle to Cycle | J_{DIFIn} | Differential Measurement | 0 | | 125 | ps | 1 |

¹ Guaranteed by design and characterization, not 100% tested in production.

² Operation under these conditions is neither implied nor guaranteed.

²Slew rate measured through +/-75mV window centered around differential zero

Electrical Characteristics-Input/Supply/Common Parameters

 $T_A = T_{COM}$; Supply Voltage $V_{DD} = 3.3 \text{ V +/-5}\%$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|----------------------------------|-----------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|--------|-----------------------|--------|-------|
| Ambient Operating Temperature | T _{COM} | Commmercial range | 0 | 35 | 70 | °C | 1 |
| Input High Voltage | V _{IH} | Single-ended inputs, except SMBus, low threshold and tri-level inputs | 2 | | V _{DD} + 0.3 | V | 1 |
| Input Low Voltage | V _{IL} | Single-ended inputs, except SMBus, low threshold and tri-level inputs | GND - 0.3 | | 0.8 | ٧ | 1 |
| | I _{IN} | Single-ended inputs, $V_{IN} = GND$, $V_{IN} = VDD$ | -5 | | 5 | uA | 1 |
| Input Current | I _{INP} | $\label{eq:VIN} Single-ended inputs \\ V_{IN} = 0 \ V; \ Inputs \ with internal \ pull-up \ resistors \\ V_{IN} = VDD; \ Inputs \ with \ internal \ pull-down \ resistors$ | -200 | | 200 | uA | 1 |
| Lauret Faranceau | F _{ibyp} | V _{DD} = 3.3 V, Bypass mode | 1 | | 150 | MHz | 2 |
| Input Frequency | F _{ipII} | V _{DD} = 3.3 V, 100MHz PLL mode | 90 | 100.00 | 110 | MHz | 2 |
| Pin Inductance | L _{pin} | | | | 7 | nΗ | 1 |
| | C _{IN} | Logic Inputs, except DIF_IN | 1.5 | | 5 | pF | 1 |
| Capacitance | C _{INDIF_IN} | DIF_IN differential clock inputs | 1.5 | | 2.7 | pF | 1,4 |
| | C _{OUT} | Output pin capacitance | | | 6 | pF | 1 |
| Clk Stabilization | T _{STAB} | From V _{DD} Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock | | 0.53 | 1 | ms | 1,2 |
| Input SS Modulation Frequency | f _{MODIN} | Allowable Frequency (Triangular Modulation) | 30 | | 33 | kHz | 1 |
| OE# Latency | t _{LATOE#} | DIF start after OE# assertion DIF stop after OE# deassertion | 4 | 8 | 12 | cycles | 1,3 |
| Tdrive_PD# | t _{DRVPD} | DIF output enable after PD# de-assertion | | | 300 | us | 1,3 |
| Tfall | t _F | Fall time of control inputs | | | 10 | ns | 1,2 |
| Trise | t _R | Rise time of control inputs | | | 10 | ns | 1,2 |
| SMBus Input Low Voltage | V_{ILSMB} | | | | 0.8 | V | 1 |
| SMBus Input High Voltage | V _{IHSMB} | | 2.1 | | V _{DDSMB} | V | 1 |
| SMBus Output Low Voltage | V _{OLSMB} | @ I _{PULLUP} | | | 0.4 | V | 1 |
| SMBus Sink Current | I _{PULLUP} | @ V _{OL} | 4 | | | mA | 1 |
| Nominal Bus Voltage | $V_{\rm DDSMB}$ | 3V to 5V +/- 10% | 2.7 | | 5.5 | V | 1 |
| SCLK/SDATA Rise Time | t _{RSMB} | (Max VIL - 0.15) to (Min VIH + 0.15) | | | 1000 | ns | 1 |
| SCLK/SDATA Fall Time | t _{FSMB} | (Min VIH + 0.15) to (Max VIL - 0.15) | | | 300 | ns | 1 |
| SMBus Operating Frequency | f _{MAXSMB} | Maximum SMBus operating frequency | | | 100 | kHz | 1,5 |

¹Guaranteed by design and characterization, not 100% tested in production.

²Control input must be monotonic from 20% to 80% of input swing.

³Time from deassertion until outputs are >200 mV

⁴DIF IN input

⁵The differential input clock must be running for the SMBus to be active

Electrical Characteristics-DIF 0.7V Low Power HCSL Outputs

 $T_A = T_{COM}$; Supply Voltage $V_{DD} = 3.3 V + /-5\%$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|------------------------|------------|-----------------------------------------------------------------------------------------|------|------|------|-------|---------|
| Slew rate | Trf | Scope averaging on | 1 | 2.9 | 4 | V/ns | 1, 2, 3 |
| Slew rate matching | ΔTrf | Slew rate matching, Scope averaging on | | 7 | 20 | % | 1, 2, 4 |
| Voltage High | VHigh | Statistical measurement on single-ended signal using oscilloscope math function. (Scope | 660 | 754 | 850 | mV | 1 |
| Voltage Low | VLow | averaging on) | | 62 | 150 | | 1 |
| Max Voltage | Vmax | Measurement on single ended signal using | | 827 | 1150 | mV | 1 |
| Min Voltage | Vmin | absolute value. (Scope averaging off) | -300 | 10 | | IIIV | 1 |
| Vswing | Vswing | Scope averaging off | 300 | 1395 | | mV | 1, 2 |
| Crossing Voltage (abs) | Vcross_abs | Scope averaging off | 300 | 453 | 550 | mV | 1, 5 |
| Crossing Voltage (var) | Δ-Vcross | Scope averaging off | | 14 | 140 | mV | 1, 6 |

¹Guaranteed by design and characterization, not 100% tested in production. $C_L = 2pF$, $Z_0 = 85\Omega$ differential trace impedance).

Electrical Characteristics-Current Consumption

 $T_A = T_{COM}$; Supply Voltage $V_{DD} = 3.3 \text{ V } +/-5\%$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|-------------------|------------------------|--------------------------------|-----|-----|-----|-------|-------|
| Operating Current | I _{DDVDDR} | 100MHz, VDDR rail | | 4 | 6 | mA | 1 |
| | I _{DDVDDAPLL} | 100MHz, VDDA rail, PLL Mode | | 14 | 20 | mA | 1 |
| | I _{DDVDDABYP} | 100MHz, VDDA rail, Bypass Mode | | 3 | 5 | mA | 1 |
| | I _{DDVDD} | 100MHz, VDD rail | | 41 | 50 | mA | 1 |
| Powerdown Current | I _{DDVDDRPD} | Power Down, VDDR Rail | | 3.5 | 5 | mA | 1 |
| | I _{DDVDDAPD} | Power Down, VDDA Rail | | 1.6 | 3 | mA | 1 |
| | I _{DDVDDPD} | Power Down, VDD Rail | | 0.3 | 2 | mA | 1 |

¹Guaranteed by design and characterization, not 100% tested in production.

² Measured from differential waveform

³ Slew rate is measured through the Vswing voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V.

⁴ Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations.

⁵ Vcross is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

 $^{^6}$ The total variation of all Vcross measurements in any particular system. Note that this is a subset of Vcross_min/max (Vcross absolute) allowed. The intent is to limit Vcross induced modulation by setting Δ -Vcross to be smaller than Vcross absolute.

 $^{^{2}}$ C_L = 2pF, Zo = 85 Ω differential trace impedance

Electrical Characteristics-Skew and Differential Jitter Parameters

 $T_A = T_{COM}$; Supply Voltage $V_{DD} = 3.3 \text{ V +/-5}\%$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|------------------------|-----------------------|-----------------------------------------------------------------------------------------|------|------|-----|-------------|-----------|
| CLK_IN, DIF[x:0] | t _{SPO_PLL} | In-to-Out Skew in PLL mode @ 100MHz nominal value @35°C, 3.3V | -100 | 53 | 100 | ps | 1,2,4,5,8 |
| CLK_IN, DIF[x:0] | t _{PD_BYP} | In-to-Out Skew in Bypass mode @ 100MHz nominal value @ 35°C, 3.3V | 2.5 | 3.4 | 4.5 | ns | 1,2,3,5,8 |
| CLK_IN, DIF[x:0] | t _{DSPO_PLL} | In-to-Out Skew Varation in PLL mode across voltage and temperature | -50 | 0 | 50 | ps | 1,2,3,5,8 |
| CLK_IN, DIF[x:0] | t _{DSPO_BYP} | In-to-Out Skew Varation in Bypass mode across voltage and temperature | -250 | 0 | 250 | ps | 1,2,3,5,8 |
| CLK_IN, DIF[x:0] | t _{DTE} | Random Differential Tracking error beween two 9ZX devices in Hi BW Mode | | 3 | 5 | ps (rms) | 1,2,3,5,8 |
| CLK_IN, DIF[x:0] | t _{DSSTE} | Random Differential Spread Spectrum Tracking error beween two 9ZX devices in Hi BW Mode | | 15 | 75 | ps | 1,2,3,5,8 |
| DIF{x:0] | t _{SKEW_ALL} | Output-to-Output Skew across all outputs (Common to Bypass and PLL mode) | | 39 | 65 | ps | 1,2,3,8 |
| PLL Jitter Peaking | jpeak-hibw | LOBW#_BYPASS_HIBW = 1 | - | | 2.5 | dB | 7,8 |
| PLL Jitter Peaking | jpeak-lobw | LOBW#_BYPASS_HIBW = 0 | | | 2 | dB | 7,8 |
| PLL Bandwidth | pll _{HIBW} | LOBW#_BYPASS_HIBW = 1 | | | 4 | MHz | 8,9 |
| PLL Bandwidth | pll _{LOBW} | LOBW#_BYPASS_HIBW = 0 | | | 1.4 | MHz | 8,9 |
| Duty Cycle | t _{DC} | Measured differentially, PLL Mode | 45 | 50.1 | 55 | % | 1 |
| Duty Cycle Distortion | t _{DCD} | Measured differentially, Bypass Mode @100MHz | | -1.7 | 121 | % | 1,10 |
| Jitter, Cycle to cycle | t | PLL mode | | 14 | 50 | ps | 1,11 |
| onto, Cycle to cycle | t _{jcyc-cyc} | Additive Jitter in Bypass Mode | | 0 | 25 | ps | 1,11 |

Notes for preceding table:

 $^{^{1}}$ C_L = 2pF, Zo = 85 Ω differential trace impedance. Input to output skew is measured at the first output edge following the corresponding input.

² Measured from differential cross-point to differential cross-point. This parameter can be tuned with external feedback path, if present.

³ All Bypass Mode Input-to-Output specs refer to the timing between an input edge and the specific output edge created by it.

⁴ This parameter is deterministic for a given device

⁵ Measured with scope averaging on to find mean value.

⁶t is the period of the input clock

⁷ Measured as maximum pass band gain. At frequencies within the loop BW, highest point of magnification is called PLL jitter peaking.

^{8.} Guaranteed by design and characterization, not 100% tested in production.

⁹ Measured at 3 db down or half power point.

¹⁰ Duty cycle distortion is the difference in duty cycle between the output and the input clock when the device is operated in bypass mode.

¹¹ Measured from differential waveform

Electrical Characteristics-Phase Jitter Parameters

 $T_A = T_{COM}$; Supply Voltage $V_{DD} = 3.3 \text{ V} + /-5\%$

| | 0.4.50 | | | | | INDUSTRY | | |
|------------------------|-------------------------|-------------------------------------------------------|-----|------|------|----------|-------------|---------|
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | LIMIT | UNITS | Notes |
| | t _{jphPCleG1} | PCIe Gen 1 | | 43 | 46 | 86 | ps (p-p) | 1,2,3 |
| | | PCIe Gen 2 Lo Band 10kHz < f < 1.5MHz | | 1.4 | 1.5 | 3 | ps (rms) | 1,2 |
| | t _{jphPCleG2} | PCIe Gen 2 High Band | | | | | ` ' | |
| | | 1.5MHz < f < Nyquist (50MHz) | | 2.4 | 2.7 | 3.1 | ps (rms) | 1,2 |
| | | PCIe Gen 3 | | 0.50 | 2.24 | | ps | |
| | t _{jphPCleG3} | (PLL BW of 2-4MHz, 2-5MHz, CDR = 10MHz) | | 0.56 | 0.61 | 1 | (rms) | 1,2,4 |
| | | QPI & SMI | | | | | ps | |
| Phase Jitter, PLL Mode | | (PLL BW of 17.04MHz 100/133MHz, 4.8Gb/s, | | 0.27 | 0.51 | 1 | (rms) | 1,5 |
| | | 6.4Gb/s 12UI) | | | | | (11113) | |
| | | QPI & SMI | | | | | ps | |
| | t _{iphQPI} SMI | (PLL BW of 7.8MHz 100/133MHz, 4.8Gb/s, | | 0.22 | 0.49 | 0.5 | (rms) | 1,5 |
| | jprice i_own | 6.4Gb/s 12UI) | , | | | | ` ′ | |
| | | QPI & SMI | | 0.16 | 0.28 | 0.3 | ps (mas) | 1,5 |
| | | (100MHz, 8.0Gb/s, 12UI) QPI & SMI | | | | | (rms) | |
| | | (100MHz, 9.6Gb/s, 12UI) | | 0.11 | 0.17 | 0.2 | ps (rms) | 1,5 |
| | t _{iphPCleG1} | PCIe Gen 1 | | 1 | 5 | N/A | ps (p-p) | 1,2,3 |
| | jpiii cica i | PCIe Gen 2 Lo Band | | | | | ps | |
| | t _{jphPCleG2} | 10kHz < f < 1.5MHz | | 0.0 | 0.0 | N/A | (rms) | 1,2,6 |
| | | PCIe Gen 2 High Band | | 0.0 | 0.0 | N/A | ps | 1,2,6 |
| | | 1.5MHz < f < Nyquist (50MHz) | | 0.0 | 0.0 | IN/A | (rms) | 1,2,0 |
| | t _{jphPCleG3} | PCIe Gen 3 | | 0.0 | 0.0 | N/A | ps | 1,2,4,6 |
| | JpnPCleG3 | (PLL BW of 2-4MHz, 2-5MHz, CDR = 10MHz) | | 0.0 | 0.0 | | (rms) | 1,2,7, |
| AdditivePhase Jitter, | | QPI & SMI | | | | | ps | |
| Bypass mode | | (PLL BW of 17.04MHz 100/133MHz, 4.8Gb/s, | | 0.25 | 0.3 | N/A | (rms) | 1,5,6 |
| | | 6.4Gb/s 12UI) | | | | | ` , | |
| | | QPI & SMI | | 0.10 | 0.45 | N/A | ps | 1 |
| | t _{iphQPI_SMI} | (PLL BW of 7.8MHz 100/133MHz, 4.8Gb/s, 6.4Gb/s 12UI) | | 0.10 | 0.15 | IN/A | (rms) | 1,5,6 |
| | | 0.4GD/S 12OI) QPI & SMI | | | | | ne | |
| | | (100MHz, 8.0Gb/s, 12UI) | | 0.0 | 0.0 | N/A | ps (rms) | 1,5,6 |
| | | QPI & SMI | | | | | ps | |
| | | (100MHz, 9.6Gb/s, 12UI) | | 0.0 | 0.0 | N/A | (rms) | 1,5,6 |

¹ Applies to all outputs.

² See http://www.pcisig.com for complete specs

³ Sample size of at least 100K cycles. This figures extrapolates to 108ps pk-pk @ 1M cycles for a BER of 1-12.

⁴ Subject to final ratification by PCI SIG.

⁵ Calculated from Intel-supplied Clock Jitter Tool

 $^{^6}$ For RMS figures, additive jitter is calculated by solving the following equation: (Additive jitter) 2 - (total jitter) 2 - (input jitter) 2

Clock Periods-Differential Outputs with Spread Spectrum Disabled

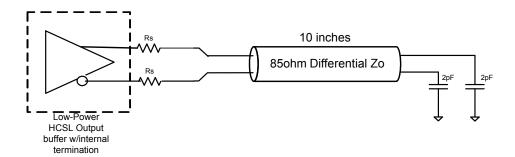
| | | Measurement Window | | | | | | | | |
|---------|--------------|------------------------------|--------------------------------------|--------------------------------------|----------------------------|--------------------------------------|--------------------------------------|------------------------------|-------|-------|
| | Center | 1 Clock | 1us | 0.1s | 0.1s | 0.1s | 1us | 1 Clock | | |
| SSC OFF | Freq. MHz | -c2c jitter AbsPer Min | -SSC Short-Term Average Min | - ppm Long-Term Average Min | 0 ppm Period Nominal | + ppm Long-Term Average Max | +SSC Short-Term Average Max | +c2c jitter AbsPer Max | Units | Notes |
| DIF | 100.00 | 9.94900 | | 9.99900 | 10.00000 | 10.00100 | | 10.05100 | ns | 1,2,3 |

Clock Periods-Differential Outputs with Spread Spectrum Enabled

| | | Measurement Window | | | | | | | | |
|--------|------------------------|------------------------------|--------------------------------------|--------------------------------------|----------------------------|--------------------------------------|--------------------------------------|------------------------------|-------|-------|
| | Comton | 1 Clock | 1us | 0.1s | 0.1s | 0.1s | 1us | 1 Clock | | |
| SSC ON | Center Freq. MHz | -c2c jitter AbsPer Min | -SSC Short-Term Average Min | - ppm Long-Term Average Min | 0 ppm Period Nominal | + ppm Long-Term Average Max | +SSC Short-Term Average Max | +c2c jitter AbsPer Max | Units | Notes |
| DIF | 99.75 | 9.94906 | 9.99906 | 10.02406 | 10.02506 | 10.02607 | 10.05107 | 10.10107 | ns | 1,2,3 |

Notes:

Test Loads



Differential Output Terminations

| Dinordina Garpar Tollinia | |
|---------------------------|--------|
| DIF Zo (Ω) | Rs (Ω) |
| 100 | 7 |
| 85 | 0 |

Note: No resistors are required for connection to 85ohm transmission lines.

¹Guaranteed by design and characterization, not 100% tested in production.

² All Long Term Accuracy specifications are guaranteed with the assumption that the input clock complies with CK420BQ/CK410B+ accuracy requirements (+/-100ppm). The 6V61036 itself does not contribute to ppm error.

³ Driven by SRC output of main clock, 100 MHz PLL Mode or Bypass mode

General SMBus Serial Interface Information for IDT6V61036

How to Write

- · Controller (host) sends a start bit
- Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) sends the byte count = X
- IDT clock will acknowledge
- Controller (host) starts sending Byte N through Byte N+X-1
- IDT clock will acknowledge each byte one at a time
- Controller (host) sends a Stop bit

| | Index BI | ock ' | Write Operation |
|-----------|-----------|--------|----------------------|
| Controll | er (Host) | | IDT (Slave/Receiver) |
| Т | starT bit | | |
| Slave A | Address | | |
| WR | WRite | | |
| | | | ACK |
| Beginning | Byte = N | | |
| | | | ACK |
| Data Byte | Count = X | | |
| | | | ACK |
| Beginnin | g Byte N | | |
| | | | ACK |
| 0 | | × | |
| 0 | | X Byte | 0 |
| 0 | | Ö | 0 |
| | | | 0 |
| Byte N | + X - 1 | | |
| | | | ACK |
| Р | stoP bit | | |

How to Read

- · Controller (host) will send a start bit
- Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) will send a separate start bit
- Controller (host) sends the read address
- IDT clock will acknowledge
- IDT clock will send the data byte count = X
- IDT clock sends Byte N+X-1
- IDT clock sends Byte 0 through Byte X (if X_(H) was written to Byte 8)
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- · Controller (host) will send a stop bit

| | Index Block F | Read O | peration |
|------|-------------------|--------|----------------------|
| Cor | ntroller (Host) | | IDT (Slave/Receiver) |
| Т | starT bit | | |
| SI | ave Address | | |
| WR | WRite | | |
| | | | ACK |
| Begi | nning Byte = N | | |
| | | | ACK |
| RT | Repeat starT | | |
| SI | ave Address | | |
| RD | ReaD | | |
| | | | ACK |
| | | | |
| | • | | Data Byte Count=X |
| | ACK | | |
| | | | Beginning Byte N |
| | ACK | | |
| | | e | 0 |
| | 0 | X Byte | 0 |
| | 0 | × | 0 |
| | 0 | | |
| | | | Byte N + X - 1 |
| N | N Not acknowledge | | |
| Р | stoP bit | | |

SMBusTable: PLL Mode, and Frequency Select Register

| Byte | 0 Pin# | Name | Control Function | Type | 0 | 1 | Default | |
|-------|--------|------------|------------------------------|------|----------------|---------------|---------|--|
| Bit 7 | 2 | PLL Mode 1 | PLL Operating Mode Rd back 1 | R | See PLL Op | erating Mode | Latch | |
| Bit 6 | 2 | PLL Mode 0 | PLL Operating Mode Rd back 0 | R | Readba | Latch | | |
| Bit 5 | | | Reserved | | | | | |
| Bit 4 | | | Reserved | | | | | |
| Bit 3 | | PLL_SW_EN | Enable S/W control of PLL BW | RW | HW Latch | SMBus Control | 0 | |
| Bit 2 | | PLL Mode 1 | PLL Operating Mode 1 | RW | See PLL Op | erating Mode | 1 | |
| Bit 1 | | PLL Mode 0 | PLL Operating Mode 1 | RW | Readback Table | | 1 | |
| Bit 0 | | | Reserved | | | | 1 | |

Note: Setting bit 3 to '1' allows the user to overide the Latch value from pin 5 via use of bits 2 and 1. Use the values from the PLL Operating Mode Readback Table. Note that Bits 7 and 6 will keep the value originally latched on pin 5. A warm reset of the system will have to accomplished if the user changes these bits.

SMBusTable: Output Control Register

| Byte | 1 | Pin # | Name | Control Function | Type | 0 | 1 | Default | |
|-------|---|-------|----------|----------------------------------------|------|---------|--------|---------|--|
| Bit 7 | | | | Reserved | | | | 1 | |
| Bit 6 | 2 | 6/27 | DIF_3_En | Output Control - '0' overrides OE# pin | RW | Low/Low | Enable | 1 | |
| Bit 5 | 2 | 3/24 | DIF_2_En | Output Control - '0' overrides OE# pin | RW | LOW/LOW | Enable | 1 | |
| Bit 4 | | | | Reserved | | | | | |
| Bit 3 | | | | Reserved | | | | 1 | |
| Bit 2 | 1 | 7/18 | DIF_1_En | Output Control - '0' overrides OE# pin | RW | Low/Low | Enable | 1 | |
| Bit 1 | 1 | 4/15 | DIF_0_En | Output Control - '0' overrides OE# pin | RW | Low/Low | Enable | 1 | |
| Bit 0 | | | | Reserved | | | | 1 | |

SMBusTable: Output Control Register

| Byte | e 2 | Pin # | Name | Control Function | Type | 0 | 1 | Default | | |
|-------|-----|-------|----------|----------------------------------------|------|---------|--------|---------|--|--|
| Bit 7 | | | | Reserved | | | | 0 | | |
| Bit 6 | | | | Reserved | | | | | | |
| Bit 5 | | | | Reserved | | | | | | |
| Bit 4 | | | | Reserved | | | | | | |
| Bit 3 | | | | Reserved | | | | 1 | | |
| Bit 2 | 3 | 6/37 | DIF_5_En | Output Control - '0' overrides OE# pin | RW | Low/Low | Enable | 1 | | |
| Bit 1 | 3 | 3/34 | DIF_4_En | Output Control - '0' overrides OE# pin | RW | Low/Low | Enable | 1 | | |
| Bit 0 | | | | Reserved | | | | 1 | | |

SMBusTable: Reserved Register

| Byte | 3 | Pin # | Name | Control Function | Type | 0 | 1 | Default | | |
|-------|---|-------|------|------------------|------|---|---|---------|--|--|
| Bit 7 | | | | Reserved | | | | 0 | | |
| Bit 6 | | | | Reserved | | | | | | |
| Bit 5 | | | | Reserved | | | | | | |
| Bit 4 | | | | Reserved | | | | | | |
| Bit 3 | | | | Reserved | | | | 0 | | |
| Bit 2 | | | | Reserved | | | | 0 | | |
| Bit 1 | | | | Reserved | | | | 0 | | |
| Bit 0 | | | | Reserved | | | | 0 | | |

SMBusTable: Reserved Register

| Byte | 4 | Pin # | Name | Control Function | Type | 0 | 1 | Default |
|-------|---|-------|------|------------------|------|---|---|---------|
| Bit 7 | | | | Reserved | | | • | 0 |
| Bit 6 | | | | Reserved | | | | 0 |
| Bit 5 | | | | Reserved | | | | 0 |
| Bit 4 | | | | Reserved | | | | 0 |
| Bit 3 | | | | Reserved | | | | 0 |
| Bit 2 | | | | Reserved | | | | 0 |
| Bit 1 | | | | Reserved | | | | 0 |
| Bit 0 | | | | Reserved | | | | 0 |

SMBusTable: Vendor & Revision ID Register

| Byte | 5 Pin # | Name | Control Function | Type | 0 | 1 | Default |
|-------|---------|------|------------------|------|-------|---|---------|
| Bit 7 | - | RID3 | | R | • | | Х |
| Bit 6 | | RID2 | DEVISION ID | R | A rev | X | |
| Bit 5 | | RID1 | REVISION ID | R | A lev | X | |
| Bit 4 | - | RID0 | | R | | X | |
| Bit 3 | - | VID3 | VENDOR ID | R | - | - | 0 |
| Bit 2 | - | VID2 | | R | - | - | 0 |
| Bit 1 | - | VID1 | | R | - | - | 0 |
| Bit 0 | - | VID0 | | R | - | - | 1 |

SMBusTable: DEVICE ID

| Byte 6 | Pin # | Name | Control Function | Type | 0 | 1 | Default |
|--------|-------|-------------------------------------------------|------------------|------|----|-----|---------|
| Bit 7 | - | D | evice ID 7 (MSB) | R | | 1 | |
| Bit 6 | - | Device ID 6 Device ID 5 Device ID 4 Device ID 3 | | R | | | 1 |
| Bit 5 | - | | | R | | | 1 |
| Bit 4 | - | | | R | | Hex | 1 |
| Bit 3 | - | | | R | ГР | пех | 1 |
| Bit 2 | - | | Device ID 2 | R | | | 0 |
| Bit 1 | - | Device ID 1 | | R | | | 1 |
| Bit 0 | - | | Device ID 0 | R | | | 1 |

SMBusTable: Byte Count Register

| Byte | 7 Pin # | Name | Control Function | Type | 0 | 1 | Default | | |
|-------|---------|------|-----------------------------------------|------|------------------|-------------------|---------|--|--|
| Bit 7 | | | Reserved | | | | | | |
| Bit 6 | | | Reserved | | | | | | |
| Bit 5 | | | Reserved | | | | | | |
| Bit 4 | - | BC4 | | RW | | | 0 | | |
| Bit 3 | - | BC3 | Writing to this register configures how | RW | Default value | is 8 hex, so 9 | 1 | | |
| Bit 2 | - | BC2 | | RW | bytes (0 to 8) w | vill be read back | 0 | | |
| Bit 1 | - | BC1 | many bytes will be read back. | RW | by de | efault. | 0 | | |
| Bit 0 | _ | BC0 | | RW |] | | 0 | | |

SMBusTable: Reserved Register

| Byte | e 8 | Pin# | Name | Control Function | Type | 0 | 1 | Default | | | | | |
|-------|-----|------|----------|------------------|------|---|---|---------|--|--|--|--|--|
| Bit 7 | | | | Reserved | | | | | | | | | |
| Bit 6 | | | | Reserved | | | | | | | | | |
| Bit 5 | | | | Reserved | | | | | | | | | |
| Bit 4 | | | Reserved | | | | | | | | | | |
| Bit 3 | | | Reserved | | | | | | | | | | |
| Bit 2 | | | Reserved | | | | | | | | | | |
| Bit 1 | | | Reserved | | | | | | | | | | |
| Bit 0 | | | | Reserved | | | | | | | | | |

Marking Diagram

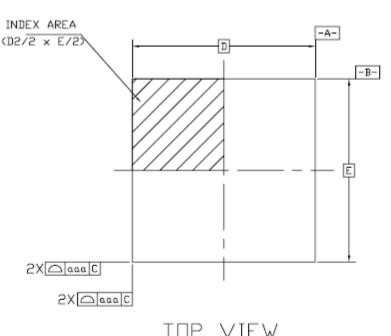
IDT6V6 1036NDG YYWW\$ ● LOT

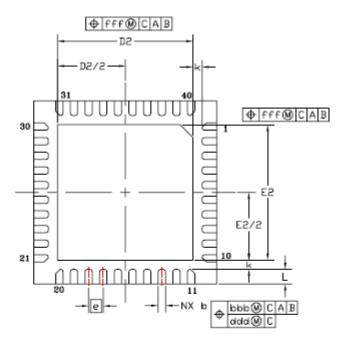
Notes:

- 1. "G" denotes RoHS compliant package.
- 2. "YYWW" is the last two digits of the year and week that the part was assembled.
- 3. "\$" denotes mark code.
- 4. 'LOT' denotes the lot number.

Package Outline and Package Dimensions (NDG40)

Package dimensions are kept current with JEDEC Publication No. 95

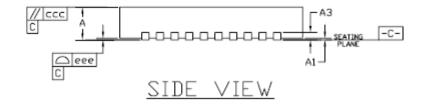




| | Р. | \checkmark | Ι | Ε | W | |
|--|----|------------------|---|---|---|--|
| | | | | | | |

| $B\square$ | Τ | Τ | \square M | \vee | ΙE | W |
|------------|---|---|-------------|--------|----|---|
|------------|---|---|-------------|--------|----|---|

| SYMBOL | | DIMENSIC | N | | | |
|--------|-------------|----------|--------|--|--|--|
| 유 | MIN | NOM | MAX | | | |
| Ь | 0.15 | 0.20 | 0.25 | | | |
| D | 5 | .00 BSC | | | | |
| E | 5 | 5.00 BSC | | | | |
| D2 | 3.40 | 3.50 | 3.60 | | | |
| E2 | 3.40 | 3.50 | 3.60 | | | |
| L | 0.30 | 0.40 | 0.50 | | | |
| е | 0 | 0.40 BSC | | | | |
| N | 40 | | | | | |
| ND | 10 (note 3) | | | | | |
| NE | | 10 (n | ote 3) | | | |
| Α | 0.80 | | 1.00 | | | |
| A1 | 0.00 | 0.02 | 0.05 | | | |
| A3 | | 0.2 REF | | | | |
| k | | 0.35 | | | | |
| aaa | | 0.10 | | | | |
| bbb | | 0.07 | | | | |
| ccc | | 0.10 | | | | |
| ddd | | 0.05 | | | | |
| eee | | 0.08 | | | | |
| fff | | 0.10 | | | | |
| | | | | | | |



NOTES:

- 1. ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5M-1982
- 2 ALL DIMENSIONS ARE IN MILLIMETERS.
- 3. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.

Ordering Information

| Part / Order Number | Shipping Package | Package | Temperature |
|---------------------|------------------|---------------|-------------|
| 6V61036NDG | Trays | 40-pin VFQFPN | 0 to +70°C |
| 6V61036NDG8 | Tape and Reel | 40-pin VFQFPN | 0 to +70°C |

"G" after the two-letter package code denotes Pb-Free configuration, RoHS compliant.

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Revision History

| Rev. | Issuer | Issue Date | Description | Page # |
|------|--------|------------|---------------------------------------------------------------------------------------------------------------------------------|---------|
| Α | RDW | 12/11/2012 | Initial release | |
| В | RDW | 3/31/2014 | Update electrical tables per latest characterization data. | Various |
| С | RDW | 11/25/2014 | Updates to Byte 6, bits 7:4; default should be "1". Updated device ID in Byte 6 from "8B" to "FB". | 11 |
| D | RDW | 3/30/2015 | 1. Corrected Test Loads to remove references to IREF and Rp. These are not present on parts that have LP-HCSL outputs. | 9 |
| Е | RDW | 11/20/2015 | Updated QPI references to QPI/UPI Updated DIF_IN table to match PCI SIG specification, no silicon change | 1,4 |

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